

U.S. UTILITY Patent Application

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O.I.P.E.

PATENT DATE

SCANNED Hlm 3 Q.A.

APPLICATION NO. 09/986445	CONT/PRIOR F	CLASS 438	SUBCLASS 530	ART UNIT 2912 5829	EXAMINER GCR
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Method for fabricating a contact pad of semiconductor device

TITLE

PTD-2040
12/99

ISSUING CLASSIFICATION

TERMINAL DISCLAIMER	DRAWINGS			CLAIMS ALLOWED	
	Sheets Drwg.	Figs. Drwg.	Print Fig.	Total Claims	Print Claim for O.G.
<input type="checkbox"/> The term of this patent subsequent to _____ (date) has been disclaimed.				NOTICE OF ALLOWANCE MAILED	
<input type="checkbox"/> The term of this patent shall not extend beyond the expiration date of U.S Patent. No. _____ _____ _____				ISSUE FEE	
<input type="checkbox"/> Th terminal _____ months of this patent have b en disclaimed.				ISSUE BATCH NUMBER	
	(Assistant Examiner)	(Date)		(Primary Examiner)	(Date)
	(Legal Instruments Examiner)		(Date)		(Date)

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